<u>MOSFET</u> – P-Channel, Small Signal, SOT-563

-20 V, -950 mA

Features

- Low R_{DS(on)} Improving System Efficiency
- Low Threshold Voltage
- Small Footprint 1.6 x 1.6 mm
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- Load/Power Switches
- Battery Management
- Cell Phones, Digital Cameras, PDAs, Pagers, etc.

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted.)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	-20	V
Gate-to-Source Voltage			V _{GS}	±8.0	V
Continuous Drain Current	Steady T _A = 25°C		1-	-860	mA
(Note 1)	State	$T_A = 70^{\circ}C$	ID	-690	
Power Dissipation (Note 1)	Steady State		P _D	170	mW
Continuous Drain Current	t≤5s	$T_A = 25^{\circ}C$	1-	-950	mA
(Note 1)	1 2 3 3	$T_A = 70^{\circ}C$	ID	-760	
Power Dissipation (Note 1)	t ≤ 5 s		P _D	210	mW
Pulsed Drain Current	t _p = 10 μs		I _{DM}	-4.0	А
Operating Junction and Storage Temperature			T _J , T _{STG}	–55 to 150	°C
Source Current (Body Diode)			IS	-360	mA
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		ΤL	260	°C	

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Max	Unit
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	720	°C/W
Junction–to–Ambient – $t \le 5 s$ (Note 1)	$R_{\theta JA}$	600	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Surface-mounted on FR4 board using 1 in. sq. pad size

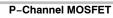
(Cu. area = 1.127 in. sq. [1 oz.] including traces).

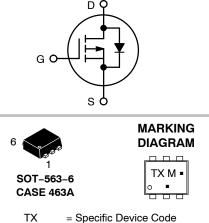


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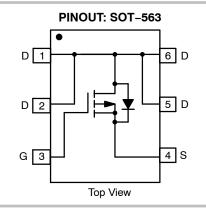
V _{(BR)DSS}	R _{DS(on)} Typ	I _D Max
	120 mΩ @ -4.5 V	
–20 V	144 mΩ @ –2.5 V	–950 mA
	195 mΩ @ –1.8 V	





M = Date Code

= Pb-Free Package
(Note: Microdot may be in either location)



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 4 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise noted.)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I_{D} = -250 µA		-20			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J				-13		mV/°C
Zero Gate Voltage Drain Current		V _{GS} = 0 V	$T_J = 25^{\circ}C$			-1.0	μA
	I _{DSS}	$V_{DS} = -20 V$	T _J = 125°C			-5.0	
Gate-to-Source Leakage Current	I _{GSS}	V_{DS} = 0 V, V_{GS} = ±8.0 V				±100	nA
ON CHARACTERISTICS (Note 2)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D = -250 \ \mu A$		-0.45		-1.0	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				2.4		mV/°C
Drain-to-Source On Resistance		V_{GS} = -4.5 V, I _D = -950 mA			120	150	mΩ
		V_{GS} = -4.5 V, I _D = -770 mA			112	142	
	R _{DS(on)}	V_{GS} = -2.5 V, I _D = -670 mA			144	200	
		V_{GS} = -1.8 V, I _D = -200 mA			195	240	
Forward Transconductance	9 FS	$V_{DS} = -10 \text{ V}, \text{ I}_{D}$	= -810 mA		3.1		S
CHARGES AND CAPACITANCES							
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1.0 MHz, V _{DS} = -16 V			458		pF
Output Capacitance	C _{OSS}				61		1
Reverse Transfer Capacitance	C _{RSS}				38		
Total Gate Charge	Q _{G(TOT)}				5.6		nC
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = –4.5 V, V _E I _D = –770	os = −10 V;		0.6		1
Gate-to-Source Charge	Q _{GS}	ID = -110	111A		0.9		
Gate-to-Drain Charge	Q _{GD}				1.2		
SWITCHING CHARACTERISTICS (Note	e 3)						
Turn-On Delay Time	t _{d(ON)}				5.0		ns
Rise Time	t _r	V _{GS} = -4.5 V. Vr	ор = –10 V,		12		1
Turn-Off Delay Time	t _{d(OFF)}	V_{GS} = -4.5 V, V_{DD} = -10 V, I_{D} = -950 mA, R_{G} = 6.0 Ω			23.7		1
Fall Time	t _f				18		1
DRAIN-SOURCE DIODE CHARACTER	ISTICS				-		-
Forward Diode Voltage		V _{GS} = 0 V,	$T_J = 25^{\circ}C$		-0.64	-0.9	V
	V _{SD}	$I_{\rm S} = -360 \rm{mA}$	T _J = 125°C		-0.5		1

Reverse Recovery Time

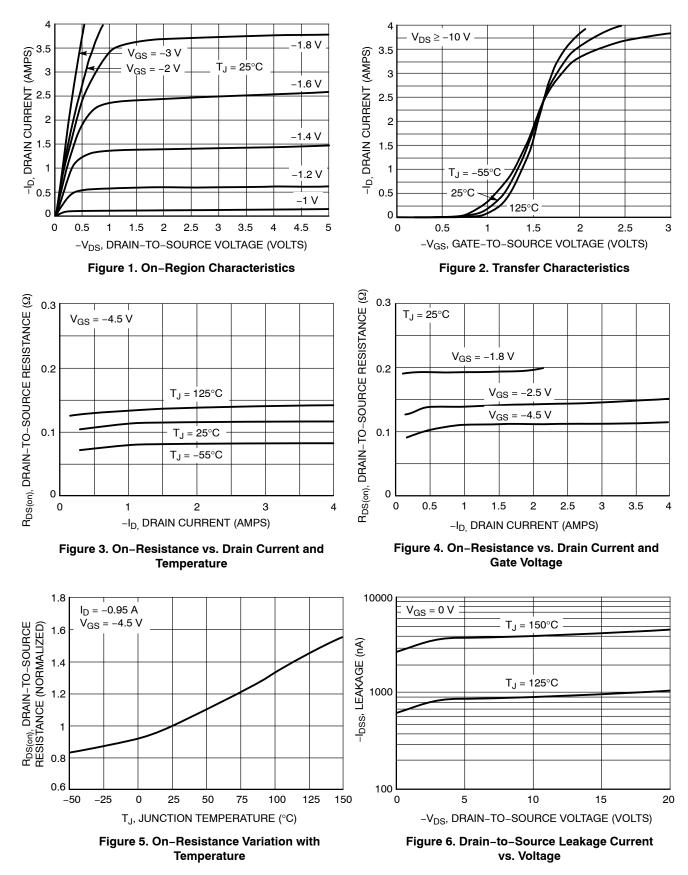
Pulse Test: pulse width ≤ 300 µs, duty cycle ≤ 2%.
Switching characteristics are independent of operating junction temperatures.

t_{RR}

 $\label{eq:VGS} \begin{array}{l} V_{GS} = 0 \ V, \ dI_S/dt = 100 \ A/\mu s, \\ I_S = -360 \ mA \end{array}$

10.5

ns



TYPICAL PERFORMANCE CURVES (T_J = 25° C unless otherwise noted)

TYPICAL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)

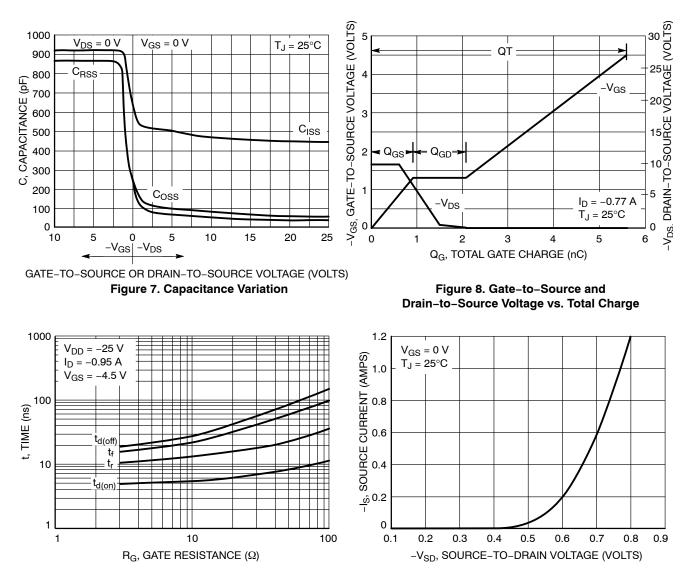


Figure 9. Resistive Switching Time Variation vs. Gate Resistance



ORDERING INFORMATION

Device	Package	Shipping
NTZS3151PT1G	SOT-563 (Pb-Free)	4000 / Tape & Reel
NTZS3151PT1H	SOT-563 (Pb-Free)	4000 / Tape & Reel
NTZS3151PT5G	SOT-563 (Pb-Free)	8000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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SOT-563, 6 LEAD CASE 463A ISSUE H

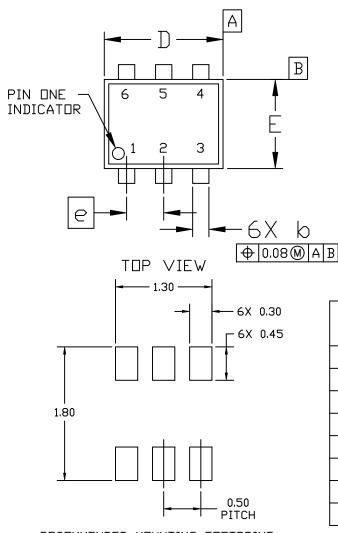
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А

- 1. DIMENSIONING AND TOLERANCING PER A 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS DF BASE MATERIAL.



SIDE VIEW MILLIMETERS DIM MIN. NDM. MAX. 0.50 0.55 0.60 Α 0.17 0.22 0.27 b 0.08 0.13 0.18 С 1.50 1.60 1.70 D Ε 1.10 1.20 1.30 0.50 BSC e L 0.10 0.20 0.30 H_E 1.50 1.60 1.70

(

RECOMMENDED MOUNTING FOOTPRINT* * For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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STYLE 1:	STYLE 2:	STYLE 3:
PIN 1. EMITTER 1	PIN 1. EMITTER 1	PIN 1. CATHIDE 1
2. BASE 1	2. EMITTER 2	2. CATHIDE 1
3. COLLECTOR 2	3. BASE 2	3. ANUDE/ANUDE 2
4. EMITTER 2	4. COLLECTOR 2	4. CATHIDE 2
5. BASE 2	5. BASE 1	5. CATHIDE 2
6. COLLECTOR 1	6. COLLECTOR 1	6. ANUDE/ANUDE 1
STYLE 4:	STYLE 5:	STYLE 6:
PIN 1. COLLECTOR	PIN 1. CATHEDE	PIN 1. CATHODE
2. COLLECTOR	2. CATHEDE	2. ANODE
3. BASE	3. ANEDE	3. CATHODE
4. EMITTER	4. ANEDE	4. CATHODE
5. COLLECTOR	5. CATHEDE	5. CATHODE
6. COLLECTOR	6. CATHEDE	6. CATHODE
STYLE 7:	STYLE 8:	STYLE 9:
PIN 1. CATHODE	PIN 1. DRAIN	PIN 1. SDURCE 1
2. ANODE	2. DRAIN	2. GATE 1
3. CATHODE	3. GATE	3. DRAIN 2
4. CATHODE	4. SDURCE	4. SDURCE 2
5. ANODE	5. DRAIN	5. GATE 2
6. CATHODE	6. DRAIN	6. DRAIN 1
STYLE 10: PIN 1. CATHIDE 1 2. N/C 3. CATHIDE 2 4. ANIDE 2 5. N/C C ANIDE 1	STYLE 11: PIN 1. EMITTER 2 2. BASE 2 3. COLLECTOR 1 4. EMITTER 1 5. BASE 1 6. COLLECTOR 2	

6. COLLECTOR 2

DATE 26 JAN 2021

GENERIC **MARKING DIAGRAM***



XX = Specific Device Code

M = Month Code

. = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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